imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

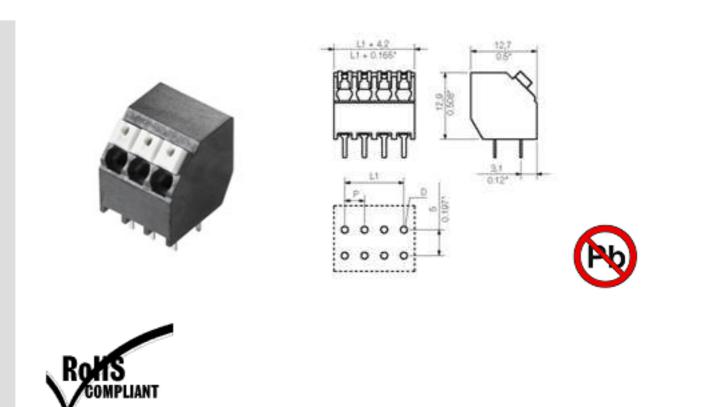
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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General ordering data

Order No. Part designation Version

EAN Qty.

System parameters

Product family Conductor connection system Fitted to PCB Outgoing direction of conductor Pitch Pitch in inch No. of poles Fitted by customer No. of rows Solder pin length Dia. of fitting hole Fitting hole tolerance No. of solder pins per pole Stripping length 1885200000 LSF-SMT3.50/4/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tube 4032248490066 37 pc(s).

System LS
Push In
Reflow solder connection
135°
3.5 mm
0.138 inch
4
no
1
1.5 mm
1.1 mm
+ 0.1 mm
2
8 mm



System parameters	
L1 in mm	10.5 mm
L1 in inch	0.413 inch
Electric shock protection to DIN VDE 0470	IP 20
Electric shock protection to DIN VDE 0470	Safe from finger touch
Material data	
Insulating material	LCP GF
Colour	black
colour chart	Similar to RAL 9011
Insulating material group	Illa
Flammability class UL 94	V-0
CTI	>= 175
Contact base material	Copper alloy
Contact surface	tinned
Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C
Connectable conductors	
Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
AWG, min.	24
AWG, max.	16
O.D. of conductor insulation, max.	2.9 mm
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm²
With wire end ferrule, acc. to DIN 46 228/1, min.	0.25 mm²
With wire end ferrule, acc. to DIN 46 228/1, max.	1.5 mm²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm²
w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm²
DIN IEC rating data	
Rated current, min. No. pins (Tu=20°C)	17.5 A
Rated current, max. No. pins (Tu=20°C)	16 A
Rated current, min. No. pins(Tu=40°C)	17.5 A
Rated current, max. No. pins (Tu=40°C)	14 A
Rated voltage for overvoltage class/pollution	320 V
severity II/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/3	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity II/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/3	
Short-time withstand current resistance	3 x 1s with 80 A



Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor (field wiring), min.	24
AWG conductor (field wiring), max.	16
UL 1059 rating data	
Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor, min.	24
AWG conductor, min. AWG conductor, max.	

Approvals

Approvals institutes



Classifications

eClass 5.1

27-26-11-01

Similar products

Order No. 1885650000	Part designation LSF-SMT3.50/2/135 3.5
100000000	201 01110.0072/100 0.0
1887340000	LSF-SMT3.5/2/135 3.5R
1885180000	LSF-SMT3.50/2/135 1.5
1887550000	LSF-SMT3.5/2/135 1.5R
1885660000	LSF-SMT3.50/3/135 3.5
1887350000	LSF-SMT3.5/3/135 3.5R
1885190000	LSF-SMT3.50/3/135 1.5
1887560000	LSF-SMT3.5/3/135 1.5R
100700000	LSF-SIVIT3.3/3/133 1.3R
1885670000	LSF-SMT3.50/4/135 3.5
1887360000	LSF-SMT3.5/4/135 3.5R
1887580000	LSF-SMT3.5/4/135 1.5R
1885680000	LSF-SMT3.50/5/135 3.5

PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 2, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 2, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 2, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 2, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 3, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 3, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 3, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 3, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 5, 135°, Tube



1887460000	LSF-SMT3.5/5/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 5, 135°, Tape
1885210000	LSF-SMT3.50/5/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1003210000	201-01010.00/0/100 1.0	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 5, 135°, Tube
1887630000	LSF-SMT3.5/5/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 5, 135°, Tape
1885690000	LSF-SMT3.50/6/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 6, 135°, Tube
1887470000	LSF-SMT3.5/6/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 6, 135°, Tape
1885220000	LSF-SMT3.50/6/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1997640000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 6, 135°, Tube
1887640000	LSF-SMT3.5/6/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 6, 135°, Tape
1885700000	LSF-SMT3.50/7/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1003700000	LSI -SINT 3.50/// 135 5.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 7, 135°, Tube
1887480000	LSF-SMT3.5/7/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007 100000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 7, 135°, Tape
1885230000	LSF-SMT3.50/7/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1003230000	201-01110.00/1/100 1.0	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 7, 135°, Tube
1887650000	LSF-SMT3.5/7/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007050000	L3F-3M13.3/1/135 1.3K	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 7, 135°, Tape
1885710000	LSF-SMT3.50/8/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
10007 10000	201-01110.00/0/100 0.0	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 8, 135°, Tube
1887490000	LSF-SMT3.5/8/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 8, 135°, Tape
1885240000	LSF-SMT3.50/8/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 8, 135°, Tube
1887660000	LSF-SMT3.5/8/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 8, 135°, Tape
1885720000	LSF-SMT3.50/9/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 9, 135°, Tube
1887500000	LSF-SMT3.5/9/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 9, 135°, Tape
1885250000	LSF-SMT3.50/9/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 9, 135°, Tube
1887670000	LSF-SMT3.5/9/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 9, 135°, Tape
1885730000	LSF-SMT3.50/10/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
(00== (0000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 10, 135°, Tube
1887510000	LSF-SMT3.5/10/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
400500000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 10, 135°, Tape
1885260000	LSF-SMT3.50/10/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 10, 135°, Tube
1887680000	LSF-SMT3.5/10/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007000000	ESF-SWI 5.5/10/135 1.5K	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 10, 135°, Tape
1885740000	LSF-SMT3.50/11/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
10007 40000	201 01110.00/11/100 0.0	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tube
1887520000	LSF-SMT3.5/11/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007020000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tape
1885270000	LSF-SMT3.50/11/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tube
		, , , ,,,,



1887690000	LSF-SMT3.5/11/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tape
1885750000	LSF-SMT3.50/12/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
10007 00000	201-01110.00/12/100 0.0	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 12, 135°, Tube
1887530000	LSF-SMT3.5/12/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1001000000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 12, 135°, Tape
1885280000	LSF-SMT3.50/12/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 12, 135°, Tube
1887700000	LSF-SMT3.5/12/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 12, 135°, Tape
1885760000	LSF-SMT3.50/13/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 13, 135°, Tube
1885290000	LSF-SMT3.50/13/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 13, 135°, Tube
1885770000	LSF-SMT3.50/14/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 14, 135°, Tube
1885300000	LSF-SMT3.50/14/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 14, 135°, Tube
1885780000	LSF-SMT3.50/15/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
4005040000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 15, 135°, Tube
1885310000	LSF-SMT3.50/15/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885790000	LSF-SMT3.50/16/135 3.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 15, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
18857 90000	LOF-51013.50/10/135 5.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 16, 135°, Tube
1885320000	LSF-SMT3.50/16/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000020000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 16, 135°, Tube
1885800000	LSF-SMT3.50/17/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 17, 135°, Tube
1885330000	LSF-SMT3.50/17/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 17, 135°, Tube
1885810000	LSF-SMT3.50/18/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 18, 135°, Tube
1885340000	LSF-SMT3.50/18/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
400500000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 18, 135°, Tube
1885820000	LSF-SMT3.50/19/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885350000	LSF-SMT3.50/19/135 1.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 19, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1885550000	LOF-SWIT5.50/19/155 1.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 19, 135°, Tube
1885830000	LSF-SMT3.50/20/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000000000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 20, 135°, Tube
1885360000	LSF-SMT3.50/20/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 20, 135°, Tube
1885840000	LSF-SMT3.50/21/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 21, 135°, Tube
1885370000	LSF-SMT3.50/21/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 21, 135°, Tube
1885850000	LSF-SMT3.50/22/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
400500000		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 22, 135°, Tube
1885380000	LSF-SMT3.50/22/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885860000	LSF-SMT3.50/23/135 3.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 22, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1000000000	LOI - SIVIT 3. SU/23/ 153 3.3	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 23, 135°, Tube



1885390000	LSF-SMT3.50/23/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 23, 135°, Tube
1885870000	LSF-SMT3.50/24/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 24, 135°, Tube
1885400000	LSF-SMT3.50/24/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 24, 135°, Tube

